



Welcome to **E-XFL.COM** 

## Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	216
Number of Logic Elements/Cells	1728
Total RAM Bits	12288
Number of I/O	189
Number of Gates	69000
Voltage - Supply	4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	240-BFQFP Exposed Pad
Supplier Device Package	240-RQFP (32x32)
Purchase URL	https://www.e-xfl.com/product-detail/intel/epf10k30rc240-4

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

The FLEX 10K architecture is similar to that of embedded gate arrays, the fastest-growing segment of the gate array market. As with standard gate arrays, embedded gate arrays implement general logic in a conventional "sea-of-gates" architecture. In addition, embedded gate arrays have dedicated die areas for implementing large, specialized functions. By embedding functions in silicon, embedded gate arrays provide reduced die area and increased speed compared to standard gate arrays. However, embedded megafunctions typically cannot be customized, limiting the designer's options. In contrast, FLEX 10K devices are programmable, providing the designer with full control over embedded megafunctions and general logic while facilitating iterative design changes during debugging.

Each FLEX 10K device contains an embedded array and a logic array. The embedded array is used to implement a variety of memory functions or complex logic functions, such as digital signal processing (DSP), microcontroller, wide-data-path manipulation, and data-transformation functions. The logic array performs the same function as the sea-of-gates in the gate array: it is used to implement general logic, such as counters, adders, state machines, and multiplexers. The combination of embedded and logic arrays provides the high performance and high density of embedded gate arrays, enabling designers to implement an entire system on a single device.

FLEX 10K devices are configured at system power-up with data stored in an Altera serial configuration device or provided by a system controller. Altera offers the EPC1, EPC2, EPC16, and EPC1441 configuration devices, which configure FLEX 10K devices via a serial data stream. Configuration data can also be downloaded from system RAM or from Altera's BitBlaster™ serial download cable or ByteBlasterMV™ parallel port download cable. After a FLEX 10K device has been configured, it can be reconfigured in-circuit by resetting the device and loading new data. Because reconfiguration requires less than 320 ms, real-time changes can be made during system operation.

FLEX 10K devices contain an optimized interface that permits microprocessors to configure FLEX 10K devices serially or in parallel, and synchronously or asynchronously. The interface also enables microprocessors to treat a FLEX 10K device as memory and configure the device by writing to a virtual memory location, making it very easy for the designer to reconfigure the device.



For more information, see the following documents:

- Configuration Devices for APEX & FLEX Devices Data Sheet
- BitBlaster Serial Download Cable Data Sheet
- ByteBlasterMV Parallel Port Download Cable Data Sheet
- Application Note 116 (Configuring APEX 20K, FLEX 10K & FLEX 6000 Devices)

FLEX 10K devices are supported by Altera development systems; single, integrated packages that offer schematic, text (including AHDL), and waveform design entry, compilation and logic synthesis, full simulation and worst-case timing analysis, and device configuration. The Altera software provides EDIF 2 0 0 and 3 0 0, LPM, VHDL, Verilog HDL, and other interfaces for additional design entry and simulation support from other industry-standard PC- and UNIX workstation-based EDA tools.

The Altera software works easily with common gate array EDA tools for synthesis and simulation. For example, the Altera software can generate Verilog HDL files for simulation with tools such as Cadence Verilog-XL. Additionally, the Altera software contains EDA libraries that use device-specific features such as carry chains which are used for fast counter and arithmetic functions. For instance, the Synopsys Design Compiler library supplied with the Altera development systems include DesignWare functions that are optimized for the FLEX 10K architecture.

The Altera development systems run on Windows-based PCs and Sun SPARCstation, and HP 9000 Series 700/800 workstations.



See the MAX+PLUS II Programmable Logic Development System & Software Data Sheet for more information.

# Functional Description

Each FLEX 10K device contains an embedded array to implement memory and specialized logic functions, and a logic array to implement general logic.

The embedded array consists of a series of EABs. When implementing memory functions, each EAB provides 2,048 bits, which can be used to create RAM, ROM, dual-port RAM, or first-in first-out (FIFO) functions. When implementing logic, each EAB can contribute 100 to 600 gates towards complex logic functions, such as multipliers, microcontrollers, state machines, and DSP functions. EABs can be used independently, or multiple EABs can be combined to implement larger functions.

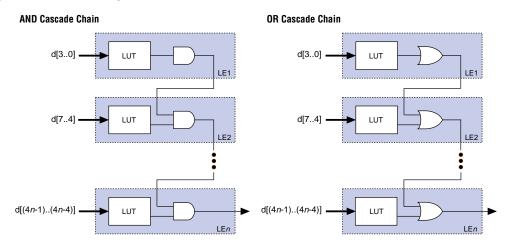
#### Cascade Chain

With the cascade chain, the FLEX 10K architecture can implement functions that have a very wide fan-in. Adjacent LUTs can be used to compute portions of the function in parallel; the cascade chain serially connects the intermediate values. The cascade chain can use a logical AND or logical OR (via De Morgan's inversion) to connect the outputs of adjacent LEs. Each additional LE provides four more inputs to the effective width of a function, with a delay as low as 0.7 ns per LE. Cascade chain logic can be created automatically by the Compiler during design processing, or manually by the designer during design entry.

Cascade chains longer than eight bits are implemented automatically by linking several LABs together. For easier routing, a long cascade chain skips every other LAB in a row. A cascade chain longer than one LAB skips either from even-numbered LAB to even-numbered LAB, or from odd-numbered LAB to odd-numbered LAB (e.g., the last LE of the first LAB in a row cascades to the first LE of the third LAB). The cascade chain does not cross the center of the row (e.g., in the EPF10K50 device, the cascade chain stops at the eighteenth LAB and a new one begins at the nineteenth LAB). This break is due to the EAB's placement in the middle of the row.

Figure 8 shows how the cascade function can connect adjacent LEs to form functions with a wide fan-in. These examples show functions of 4n variables implemented with n LEs. The LE delay is as low as 1.6 ns; the cascade chain delay is as low as 0.7 ns. With the cascade chain, 3.7 ns is needed to decode a 16-bit address.





#### LE Operating Modes

The FLEX 10K LE can operate in the following four modes:

- Normal mode
- Arithmetic mode
- Up/down counter mode
- Clearable counter mode

Each of these modes uses LE resources differently. In each mode, seven available inputs to the LE—the four data inputs from the LAB local interconnect, the feedback from the programmable register, and the carry-in and cascade-in from the previous LE—are directed to different destinations to implement the desired logic function. Three inputs to the LE provide clock, clear, and preset control for the register. The Altera software, in conjunction with parameterized functions such as LPM and DesignWare functions, automatically chooses the appropriate mode for common functions such as counters, adders, and multipliers. If required, the designer can also create special-purpose functions which use a specific LE operating mode for optimal performance.

The architecture provides a synchronous clock enable to the register in all four modes. The Altera software can set DATA1 to enable the register synchronously, providing easy implementation of fully synchronous designs.

Figure 9 shows the LE operating modes.

During compilation, the Compiler automatically selects the best control signal implementation. Because the clear and preset functions are active-low, the Compiler automatically assigns a logic high to an unused clear or preset.

The clear and preset logic is implemented in one of the following six modes chosen during design entry:

- Asynchronous clear
- Asynchronous preset
- Asynchronous clear and preset
- Asynchronous load with clear
- Asynchronous load with preset
- Asynchronous load without clear or preset

In addition to the six clear and preset modes, FLEX 10K devices provide a chip-wide reset pin that can reset all registers in the device. Use of this feature is set during design entry. In any of the clear and preset modes, the chip-wide reset overrides all other signals. Registers with asynchronous presets may be preset when the chip-wide reset is asserted. Inversion can be used to implement the asynchronous preset. Figure 10 shows examples of how to enter a section of a design for the desired functionality.

#### Asynchronous Preset

An asynchronous preset is implemented as either an asynchronous load, or with an asynchronous clear. If DATA3 is tied to  $V_{CC}$ , asserting LABCTRL1 asynchronously loads a one into the register. Alternatively, the Altera software can provide preset control by using the clear and inverting the input and output of the register. Inversion control is available for the inputs to both LEs and IOEs. Therefore, if a register is preset by only one of the two LABCTRL signals, the DATA3 input is not needed and can be used for one of the LE operating modes.

#### Asynchronous Preset & Clear

When implementing asynchronous clear and preset, LABCTRL1 controls the preset and LABCTRL2 controls the clear. DATA3 is tied to  $V_{CC}$ , therefore, asserting LABCTRL1 asynchronously loads a one into the register, effectively presetting the register. Asserting LABCTRL2 clears the register.

#### Asynchronous Load with Clear

When implementing an asynchronous load in conjunction with the clear, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear. LABCTRL2 implements the clear by controlling the register clear; LABCTRL2 does not have to feed the preset circuits.

#### Asynchronous Load with Preset

When implementing an asynchronous load in conjunction with preset, the Altera software provides preset control by using the clear and inverting the input and output of the register. Asserting LABCTRL2 presets the register, while asserting LABCTRL1 loads the register. The Altera software inverts the signal that drives DATA3 to account for the inversion of the register's output.

#### Asynchronous Load without Preset or Clear

When implementing an asynchronous load without preset or clear, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear.

For improved routing, the row interconnect is comprised of a combination of full-length and half-length channels. The full-length channels connect to all LABs in a row; the half-length channels connect to the LABs in half of the row. The EAB can be driven by the half-length channels in the left half of the row and by the full-length channels. The EAB drives out to the full-length channels. In addition to providing a predictable, row-wide interconnect, this architecture provides increased routing resources. Two neighboring LABs can be connected using a half-row channel, thereby saving the other half of the channel for the other half of the row.

Table 7 summarizes the FastTrack Interconnect resources available in each FLEX  $10 \mathrm{K}$  device.

Table 7. FLEX 1	Table 7. FLEX 10K FastTrack Interconnect Resources							
Device	Rows	Channels per Row	Columns	Channels per Column				
EPF10K10 EPF10K10A	3	144	24	24				
EPF10K20	6	144	24	24				
EPF10K30 EPF10K30A	6	216	36	24				
EPF10K40	8	216	36	24				
EPF10K50 EPF10K50V	10	216	36	24				
EPF10K70	9	312	52	24				
EPF10K100 EPF10K100A	12	312	52	24				
EPF10K130V	16	312	52	32				
EPF10K250A	20	456	76	40				

In addition to general-purpose I/O pins, FLEX 10K devices have six dedicated input pins that provide low-skew signal distribution across the device. These six inputs can be used for global clock, clear, preset, and peripheral output enable and clock enable control signals. These signals are available as control signals for all LABs and IOEs in the device.

The dedicated inputs can also be used as general-purpose data inputs because they can feed the local interconnect of each LAB in the device. However, the use of dedicated inputs as data inputs can introduce additional delay into the control signal network.

Signals on the peripheral control bus can also drive the four global signals, referred to as GLOBAL0 through GLOBAL3 in Tables 8 and 9. The internally generated signal can drive the global signal, providing the same low-skew, low-delay characteristics for an internally generated signal as for a signal driven by an input. This feature is ideal for internally generated clear or clock signals with high fan-out. When a global signal is driven by internal logic, the dedicated input pin that drives that global signal cannot be used. The dedicated input pin should be driven to a known logic state (such as ground) and not be allowed to float.

When the chip-wide output enable pin is held low, it will tri-state all pins on the device. This option can be set in the Global Project Device Options menu. Additionally, the registers in the IOE can be reset by holding the chip-wide reset pin low.

#### Row-to-IOE Connections

When an IOE is used as an input signal, it can drive two separate row channels. The signal is accessible by all LEs within that row. When an IOE is used as an output, the signal is driven by a multiplexer that selects a signal from the row channels. Up to eight IOEs connect to each side of each row channel. See Figure 14.

Figure 14. FLEX 10K Row-to-IOE Connections

The values for m and n are provided in Table 10.

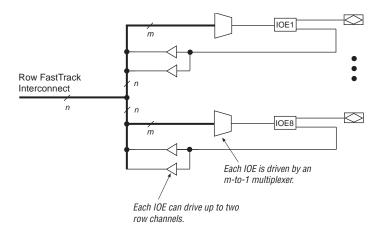


Table 1	8. FLEX 10K 5.0-V Device Reco	mmended Operating Conditions			
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CCINT</sub>	Supply voltage for internal logic and input buffers	(3), (4)	4.75 (4.50)	5.25 (5.50)	V
V <sub>CCIO</sub>	Supply voltage for output buffers, 5.0-V operation	(3), (4)	4.75 (4.50)	5.25 (5.50)	V
	Supply voltage for output buffers, 3.3-V operation	(3), (4)	3.00 (3.00)	3.60 (3.60)	V
VI	Input voltage		-0.5	V <sub>CCINT</sub> + 0.5	V
Vo	Output voltage		0	V <sub>CCIO</sub>	V
T <sub>A</sub>	Ambient temperature	For commercial use	0	70	°C
		For industrial use	-40	85	°C
T <sub>J</sub>	Operating temperature	For commercial use	0	85	°C
		For industrial use	-40	100	°C
t <sub>R</sub>	Input rise time			40	ns
t <sub>F</sub>	Input fall time			40	ns

Table 2	9. 3.3-V Device Capacitance of	Note (12)			
Symbol	Parameter	Conditions	Min	Max	Unit
C <sub>IN</sub>	Input capacitance	V <sub>IN</sub> = 0 V, f = 1.0 MHz		8	pF
C <sub>INCLK</sub>	Input capacitance on dedicated clock pin	V <sub>IN</sub> = 0 V, f = 1.0 MHz		12	pF
C <sub>OUT</sub>	Output capacitance	V <sub>OUT</sub> = 0 V, f = 1.0 MHz		8	pF

Table 3	. 3.3-V Device Capacitance of EPF10K100A Devices Note (12)						
Symbol	Parameter	Conditions	Min	Max	Unit		
C <sub>IN</sub>	Input capacitance	V <sub>IN</sub> = 0 V, f = 1.0 MHz		10	pF		
C <sub>INCLK</sub>	Input capacitance on dedicated clock pin	V <sub>IN</sub> = 0 V, f = 1.0 MHz		15	pF		
C <sub>OUT</sub>	Output capacitance	V <sub>OUT</sub> = 0 V, f = 1.0 MHz	•	10	pF		

Table 3	Table 31. 3.3-V Device Capacitance of EPF10K250A Devices     Note (12)						
Symbol	Parameter	Conditions	Min	Max	Unit		
C <sub>IN</sub>	Input capacitance	V <sub>IN</sub> = 0 V, f = 1.0 MHz		10	pF		
C <sub>INCLK</sub>	Input capacitance on dedicated clock pin	V <sub>IN</sub> = 0 V, f = 1.0 MHz		15	pF		
C <sub>OUT</sub>	Output capacitance	V <sub>OUT</sub> = 0 V, f = 1.0 MHz		10	pF		

#### Notes to tables:

- (1) See the Operating Requirements for Altera Devices Data Sheet.
- (2) Minimum DC voltage input is -0.5 V. During transitions, the inputs may undershoot to -2.0 V or overshoot to 5.75 V for input currents less than 100 mA and periods shorter than 20 ns.
- (3) Numbers in parentheses are for industrial-temperature-range devices.
- (4) Maximum  $V_{CC}$  rise time is 100 ms, and  $V_{CC}$  must rise monotonically.
- (5) FLEX 10KA device inputs may be driven before V<sub>CCINT</sub> and V<sub>CCIO</sub> are powered.
- (6) Typical values are for  $T_A = 25^{\circ}$  C and  $V_{CC} = 3.3$  V.
- (7) These values are specified under the Recommended Operating Conditions shown in Table 27 on page 51.
- (8) The I<sub>OH</sub> parameter refers to high-level TTL, PCI, or CMOS output current.
- (9) The I<sub>OL</sub> parameter refers to low-level TTL, PCI, or CMOS output current. This parameter applies to open-drain pins as well as output pins.
- (10) This value is specified for normal device operation. The value may vary during power-up.
- (11) This parameter applies to all -1 speed grade commercial temperature devices and all -2 speed grade industrial-temperature devices.
- (12) Capacitance is sample-tested only.

Symbol	-3 Spee	d Grade	-4 Spee	d Grade	Unit
	Min	Max	Min	Max	
t <sub>EABAA</sub>		13.7		17.0	ns
t <sub>EABRCCOMB</sub>	13.7		17.0		ns
t <sub>EABRCREG</sub>	9.7		11.9		ns
t <sub>EABWP</sub>	5.8		7.2		ns
t <sub>EABWCCOMB</sub>	7.3		9.0		ns
t <sub>EABWCREG</sub>	13.0		16.0		ns
t <sub>EABDD</sub>		10.0		12.5	ns
t <sub>EABDATACO</sub>		2.0		3.4	ns
t <sub>EABDATASU</sub>	5.3		5.6		ns
t <sub>EABDATAH</sub>	0.0		0.0		ns
t <sub>EABWESU</sub>	5.5		5.8		ns
t <sub>EABWEH</sub>	0.0		0.0		ns
t <sub>EABWDSU</sub>	5.5		5.8		ns
t <sub>EABWDH</sub>	0.0		0.0		ns
t <sub>EABWASU</sub>	2.1		2.7		ns
t <sub>EABWAH</sub>	0.0		0.0		ns
t <sub>EABWO</sub>		9.5		11.8	ns

Tables 48 through 56 show EPF10K30, EPF10K40, and EPF10K50 device internal and external timing parameters.

Symbol	-3 Speed Grade		-4 Spee	d Grade	Unit
	Min	Max	Min	Max	
$t_{LUT}$		1.3		1.8	ns
t <sub>CLUT</sub>		0.6		0.6	ns
t <sub>RLUT</sub>		1.5		2.0	ns
t <sub>PACKED</sub>		0.5		0.8	ns
t <sub>EN</sub>		0.9		1.5	ns
t <sub>CICO</sub>		0.2		0.4	ns
t <sub>CGEN</sub>		0.9		1.4	ns
t <sub>CGENR</sub>		0.9		1.4	ns
t <sub>CASC</sub>		1.0		1.2	ns
$t_{\mathbb{C}}$		1.3		1.6	ns
$t_{CO}$		0.9		1.2	ns
t <sub>COMB</sub>		0.6		0.6	ns
t <sub>SU</sub>	1.4		1.4		ns
$t_H$	0.9		1.3		ns
t <sub>PRE</sub>		0.9		1.2	ns
t <sub>CLR</sub>		0.9		1.2	ns
t <sub>CH</sub>	4.0		4.0		ns
$t_{CL}$	4.0		4.0		ns

Symbol	-3 Spee	d Grade	-4 Spee	Unit	
	Min	Max	Min	Max	İ
t <sub>EABDATA1</sub>		1.5		1.9	ns
t <sub>EABDATA2</sub>		4.8		6.0	ns
t <sub>EABWE1</sub>		1.0		1.2	ns
t <sub>EABWE2</sub>		5.0		6.2	ns
t <sub>EABCLK</sub>		1.0		2.2	ns
t <sub>EABCO</sub>		0.5		0.6	ns
t <sub>EABBYPASS</sub>		1.5		1.9	ns
t <sub>EABSU</sub>	1.5		1.8		ns
t <sub>EABH</sub>	2.0		2.5		ns
$t_{AA}$		8.7		10.7	ns
$t_{WP}$	5.8		7.2		ns
t <sub>WDSU</sub>	1.6		2.0		ns
t <sub>WDH</sub>	0.3		0.4		ns
t <sub>WASU</sub>	0.5		0.6		ns
t <sub>WAH</sub>	1.0		1.2		ns
$t_{WO}$		5.0		6.2	ns
t <sub>DD</sub>		5.0		6.2	ns
t <sub>EABOUT</sub>		0.5		0.6	ns
t <sub>EABCH</sub>	4.0		4.0		ns
t <sub>EABCL</sub>	5.8		7.2		ns

Symbol	-3 Speed Grade		-4 Snee	Unit	
Symbol			-4 Speed Grade		
	Min	Max	Min	Max	
t <sub>EABAA</sub>		13.7		17.0	ns
t <sub>EABRCCOMB</sub>	13.7		17.0		ns
t <sub>EABRCREG</sub>	9.7		11.9		ns
t <sub>EABWP</sub>	5.8		7.2		ns
t <sub>EABWCCOMB</sub>	7.3		9.0		ns
t <sub>EABWCREG</sub>	13.0		16.0		ns
t <sub>EABDD</sub>		10.0		12.5	ns
t <sub>EABDATACO</sub>		2.0		3.4	ns
t <sub>EABDATASU</sub>	5.3		5.6		ns
t <sub>EABDATAH</sub>	0.0		0.0		ns
t <sub>EABWESU</sub>	5.5		5.8		ns
t <sub>EABWEH</sub>	0.0		0.0		ns
t <sub>EABWDSU</sub>	5.5		5.8		ns
t <sub>EABWDH</sub>	0.0		0.0		ns
t <sub>EABWASU</sub>	2.1		2.7		ns
t <sub>EABWAH</sub>	0.0		0.0		ns
$t_{EABWO}$		9.5		11.8	ns

Symbol	-2 Speed Grade		-3 Speed Grade		-4 Speed Grade		Unit	
	Min	Max	Min	Max	Min	Max	-	
t <sub>EABDATA1</sub>		1.9		2.4		2.4	ns	
t <sub>EABDATA2</sub>		3.7		4.7		4.7	ns	
t <sub>EABWE1</sub>		1.9		2.4		2.4	ns	
t <sub>EABWE2</sub>		3.7		4.7		4.7	ns	
t <sub>EABCLK</sub>		0.7		0.9		0.9	ns	
t <sub>EABCO</sub>		0.5		0.6		0.6	ns	
t <sub>EABBYPASS</sub>		0.6		0.8		0.8	ns	
t <sub>EABSU</sub>	1.4		1.8		1.8		ns	
t <sub>EABH</sub>	0.0		0.0		0.0		ns	
$t_{AA}$		5.6		7.1		7.1	ns	
$t_{WP}$	3.7		4.7		4.7		ns	
$t_{WDSU}$	4.6		5.9		5.9		ns	
t <sub>WDH</sub>	0.0		0.0		0.0		ns	
t <sub>WASU</sub>	3.9		5.0		5.0		ns	
t <sub>WAH</sub>	0.0		0.0		0.0		ns	
$t_{WO}$		5.6		7.1		7.1	ns	
$t_{DD}$		5.6		7.1		7.1	ns	
t <sub>EABOUT</sub>		2.4		3.1		3.1	ns	
t <sub>EABCH</sub>	4.0		4.0		4.0		ns	
t <sub>EABCL</sub>	4.0		4.7		4.7		ns	

Symbol	-1 Spee	d Grade	-2 Speed Grade		-3 Spee	Unit	
	Min	Max	Min	Max	Min	Max	
t <sub>DIN2IOE</sub>		4.2		5.0		6.5	ns
t <sub>DIN2LE</sub>		2.2		2.6		3.4	ns
t <sub>DIN2DATA</sub>		4.3		5.2		7.1	ns
t <sub>DCLK2IOE</sub>		4.2		4.9		6.6	ns
t <sub>DCLK2LE</sub>		2.2		2.6		3.4	ns
t <sub>SAMELAB</sub>		0.1		0.1		0.2	ns
t <sub>SAMEROW</sub>		2.2		2.4		2.9	ns
t <sub>SAME</sub> COLUMN		0.8		1.0		1.4	ns
t <sub>DIFFROW</sub>		3.0		3.4		4.3	ns
t <sub>TWOROWS</sub>		5.2		5.8		7.2	ns
t <sub>LEPERIPH</sub>		1.8		2.2		2.8	ns
t <sub>LABCARRY</sub>		0.5		0.5		0.7	ns
t <sub>LABCASC</sub>		0.9		1.0		1.5	ns

Table 90. EPF10K10A External Reference Timing Parameters Note (1)								
Symbol	-1 Spec	ed Grade	-2 Spec	ed Grade	-3 Speed Grade		Unit	
	Min	Max	Min	Max	Min	Max		
t <sub>DRR</sub>		10.0		12.0		16.0	ns	
t <sub>INSU</sub> (2), (3)	1.6		2.1		2.8		ns	
t <sub>INH</sub> (3)	0.0		0.0		0.0		ns	
t <sub>outco</sub> (3)	2.0	5.8	2.0	6.9	2.0	9.2	ns	

Table 91. EPF10K10	Table 91. EPF10K10A Device External Bidirectional Timing Parameters       Note (1)							
Symbol	-2 Spee	d Grade	-3 Spec	ed Grade	-4 Spee	d Grade	Unit	
	Min	Max	Min	Max	Min	Max	1	
tINSUBIDIR	2.4		3.3		4.5		ns	
t <sub>INHBIDIR</sub>	0.0		0.0		0.0		ns	
toutcobidir	2.0	5.8	2.0	6.9	2.0	9.2	ns	
t <sub>XZBIDIR</sub>		6.3		7.5		9.9	ns	
t <sub>ZXBIDIR</sub>		6.3		7.5		9.9	ns	

#### Notes to tables:

- (1) All timing parameters are described in Tables 32 through 38 in this data sheet.
- (2) Using an LE to register the signal may provide a lower setup time.
- (3) This parameter is specified by characterization.

Tables 92 through 98 show EPF10K30A device internal and external timing parameters.

Table 92. EPF10K30A Device LE Timing Microparameters     Note (1)								
Symbol	-1 Spee	d Grade	-2 Spee	ed Grade	-3 Speed Grade		Unit	
	Min	Max	Min	Max	Min	Max		
$t_{LUT}$		0.8		1.1		1.5	ns	
t <sub>CLUT</sub>		0.6		0.7		1.0	ns	
t <sub>RLUT</sub>		1.2		1.5		2.0	ns	
t <sub>PACKED</sub>		0.6		0.6		1.0	ns	
t <sub>EN</sub>		1.3		1.5		2.0	ns	
t <sub>CICO</sub>		0.2		0.3		0.4	ns	
t <sub>CGEN</sub>		0.8		1.0		1.3	ns	
t <sub>CGENR</sub>		0.6		0.8		1.0	ns	
t <sub>CASC</sub>		0.9		1.1		1.4	ns	
$t_{\rm C}$		1.1		1.3		1.7	ns	
$t_{\rm CO}$		0.4		0.6		0.7	ns	
t <sub>COMB</sub>		0.6		0.7		0.9	ns	
$t_{SU}$	0.9		0.9		1.4		ns	
t <sub>H</sub>	1.1		1.3		1.7		ns	
t <sub>PRE</sub>		0.5		0.6		0.8	ns	
t <sub>CLR</sub>		0.5		0.6		0.8	ns	
t <sub>CH</sub>	3.0		3.5		4.0		ns	
$t_{CL}$	3.0		3.5		4.0		ns	

Symbol	-1 Spee	d Grade	-2 Spee	d Grade	-3 Spee	Unit	
	Min	Max	Min	Max	Min	Max	]
$t_{IOD}$		2.2		2.6		3.4	ns
t <sub>IOC</sub>		0.3		0.3		0.5	ns
t <sub>IOCO</sub>		0.2		0.2		0.3	ns
t <sub>IOCOMB</sub>		0.5		0.6		0.8	ns
t <sub>IOSU</sub>	1.4		1.7		2.2		ns

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t <sub>EABAA</sub>		9.7		11.6		16.2	ns
t <sub>EABRCCOMB</sub>	9.7		11.6		16.2		ns
t <sub>EABRCREG</sub>	5.9		7.1		9.7		ns
t <sub>EABWP</sub>	3.8		4.5		5.9		ns
t <sub>EABWCCOMB</sub>	4.0		4.7		6.3		ns
t <sub>EABWCREG</sub>	9.8		11.6		16.6		ns
t <sub>EABDD</sub>		9.2		11.0		16.1	ns
<sup>t</sup> EABDATACO		1.7		2.1		3.4	ns
t <sub>EABDATASU</sub>	2.3		2.7		3.5		ns
t <sub>EABDATAH</sub>	0.0		0.0		0.0		ns
t <sub>EABWESU</sub>	3.3		3.9		4.9		ns
t <sub>EABWEH</sub>	0.0		0.0		0.0		ns
t <sub>EABWDSU</sub>	3.2		3.8		5.0		ns
t <sub>EABWDH</sub>	0.0		0.0		0.0		ns
t <sub>EABWASU</sub>	3.7		4.4		5.1		ns
t <sub>EABWAH</sub>	0.0		0.0		0.0		ns
t <sub>EABWO</sub>		6.1		7.3		11.3	ns

#### Notes to tables:

- (1) All timing parameters are described in Tables 32 through 38 in this data sheet.
- (2) Using an LE to register the signal may provide a lower setup time.
- (3) This parameter is specified by characterization.

Tables 106 through 112 show EPF10K250A device internal and external timing parameters.

Table 106. EPF1	1		<u> </u>		1		ı
Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{LUT}$		0.9		1.0		1.4	ns
t <sub>CLUT</sub>		1.2		1.3		1.6	ns
t <sub>RLUT</sub>		2.0		2.3		2.7	ns
t <sub>PACKED</sub>		0.4		0.4		0.5	ns
$t_{EN}$		1.4		1.6		1.9	ns
$t_{CICO}$		0.2		0.3		0.3	ns
t <sub>CGEN</sub>		0.4		0.6		0.6	ns
t <sub>CGENR</sub>		0.8		1.0		1.1	ns
t <sub>CASC</sub>		0.7		0.8		1.0	ns
$t_{\mathbb{C}}$		1.2		1.3		1.6	ns
$t_{CO}$		0.6		0.7		0.9	ns
t <sub>COMB</sub>		0.5		0.6		0.7	ns
$t_{SU}$	1.2		1.4		1.7		ns
t <sub>H</sub>	1.2		1.3		1.6		ns
t <sub>PRE</sub>		0.7		0.8		0.9	ns
t <sub>CLR</sub>		0.7		0.8		0.9	ns
t <sub>CH</sub>	2.5		3.0		3.5		ns
$t_{CL}$	2.5		3.0		3.5		ns

Symbol	-1 Spee	-1 Speed Grade		-2 Speed Grade		d Grade	Unit
	Min	Max	Min	Max	Min	Max	
t <sub>EABDATA1</sub>		1.3		1.5		1.7	ns
t <sub>EABDATA2</sub>		1.3		1.5		1.7	ns
t <sub>EABWE1</sub>		0.9		1.1		1.3	ns
t <sub>EABWE2</sub>		5.0		5.7		6.7	ns
t <sub>EABCLK</sub>		0.6		0.7		0.8	ns
t <sub>EABCO</sub>		0.0		0.0		0.0	ns
t <sub>EABBYPASS</sub>		0.1		0.1		0.2	ns
t <sub>EABSU</sub>	3.8		4.3		5.0		ns
t <sub>EABH</sub>	0.7		0.8		0.9		ns
$t_{AA}$		4.5		5.0		5.9	ns
$t_{WP}$	5.6		6.4		7.5		ns
t <sub>WDSU</sub>	1.3		1.4		1.7		ns
t <sub>WDH</sub>	0.1		0.1		0.2		ns
t <sub>WASU</sub>	0.1		0.1		0.2		ns
t <sub>WAH</sub>	0.1		0.1		0.2		ns
$t_{WO}$		4.1		4.6		5.5	ns
t <sub>DD</sub>		4.1		4.6		5.5	ns
t <sub>EABOUT</sub>		0.1		0.1		0.2	ns
t <sub>EABCH</sub>	2.5		3.0		3.5		ns
t <sub>EABCL</sub>	5.6		6.4		7.5		ns